**Cover for Electronic Device**

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**Related U.S. Application Data**

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**LOC (12) Cl.** 03-01

**U.S. Cl.** D3/218

**Field of Classification Search**


CPC B65D 1/02; B65D 1/023; B65D 1/024; B65D 5/46; B65D 41/00; B65D 41/02; B65D 41/04; B65D 2501/00; B65D 2501/009

See application file for complete search history.

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**Claim**

The ornamental design for a cover for electronic device, as shown and described.

**Description**

**FIG. 1** is a front, top, and right side perspective view of a cover for electronic device, showing the claimed design;

**FIG. 2** is a front view thereof;

**FIG. 3** is a back view thereof;

**FIG. 4** is a left side view thereof;

**FIG. 5** is a right side view thereof;

**FIG. 6** is a top view thereof;

**FIG. 7** is a bottom view thereof;

**FIG. 8** is a front, bottom, and right side perspective view thereof; and,

**FIG. 9** is a rear, top, and right side perspective view thereof.

The broken lines in the figures illustrate the portions of the design that form no part of the claimed design.

1 Claim, 7 Drawing Sheets
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